



Safe Harbor Notice

Any statements set forth of forward-looking statements that involve risks and uncertainties that could cause actual results to differ materially from those in the forward-looking statements.

Potential risks and uncertainties include, but are not limited to, such factors as fluctuations in product demand, the introduction of new products, the Company's ability to maintain customer and vendor relationships, technological advancements, impact of competitive products and pricing, growth in targeted markets, risks of foreign operations, foreign exchange rates, and other information detailed from time to time.



Company Profile

Established

1981

Locations:

SAS / Hsinchu, Taiwan

SSC1, 2 – Chunan, Taiwan

GTI-TX, USA

SST – Kunshan, China











Employees

2300

Main Products

Semiconductor Wafers

Solar Ingots / Wafers

Sapphire Ingots/ Wafers

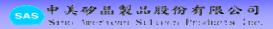
Quality System

ISO-9001

QS-9000

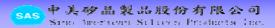
TS-16949

ISO-14001



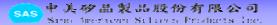
Milestones

1981	Sino-American Silicon Products Inc. established
1999	SST established in China
2000	Enter Solar Ingot / Wafer Business
2001	SAS IPO in Taiwan (OTC traded # 5483)
2004	Receive Taiwan Government's Excellent Enterprise Innovation Award
2006	SSC1 Founded in Chunan - Expansion for PV business
2007	Optoelectronics Business Unit established
2008	GlobiTech Inc. (TX USA) acquired
2008	Receive Taiwan Government's Outstanding Enterprise Innovation Award
2009	SSC 2 operation starts
2010	Vertical integration in Sino Solar/ Sunrise Global
2011	Reinvest in Powertec/Step into Sapphire ingot growing

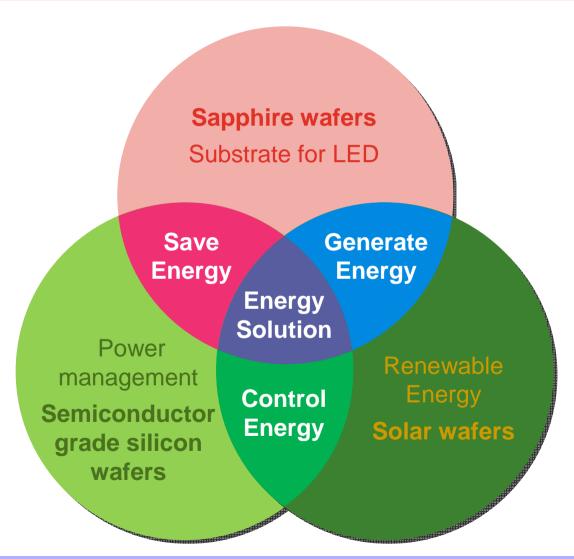


SAS Products

	Semiconductor Wafer	Solar Wafer	Sapphire Wafer
Product	Heavily-doped wafersDeep diffusion wafersSilicon-on-insulatorEpitaxial wafers	Mono and Multi ingotsMono and Multi wafers	Sapphire ingotsSapphire wafers-PW -PSS -Nano PSS
Sites	Hsinchu, Taiwan(SAS)KunShan, China(SST)Texas, USA(GTI)	Chunan Plant I, TaiwanChunan Plant II,Taiwan	● Chunan Plant I, Taiwan
Size	<i>.</i> ■3" - 8"	. ● 6"- 8"	♣2" and 4"
Application	♣ Automotive power device♣ Power discrete♣ Image sensor♠ MEMS	● Solar cell	■ LED lighting lamp ■ Back light module



Product Development Strategy



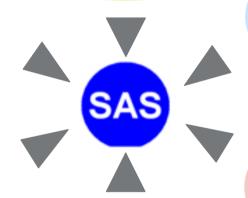


SAS Industry Position

Strong Customer and Supplier Profiles

Proven Ability to Ramp
Up and Scale
Manufacturing
Capacity Across
Different Applications

Leader in the Niche Semiconductor Wafer Market



Low Cost Manufacturing Capability Levering Semi
Capability to Tap Large
and Growing
Opportunity in Solar
and LED Markets

Proven R&D Capability from Meeting the Needs of the Solar, Semiconductor and LED markets

Sources: Company data.



Low Cost Manufacturing Capability

Cost Reduction

Lower than average material cost and stable supply

Wafer Thickness Reduction

Continuous decrease and breakthrough in thickness

Recycling

In-house slurry recycling system in place

Yield Improvement

Reduce wafer losses and higher machine throughput



Strong R&D Effort

Government Committees

- Industrial development Bureau leading plans
- Science Park Innovation Program
- •Science park plan
- National Science Council research project
- Ministry of Economic Affairs & Development Program

Research Centers

•ITRI (Industry Technology Research Institute)

Industry Alliance

•More than 10 Industry partners

Academic Institutions

- National Taiwan University
- National Cheng Kung University
- National Tsing Hua University
- National Chiao Tung University
- Nanyang Technological University, Singapore

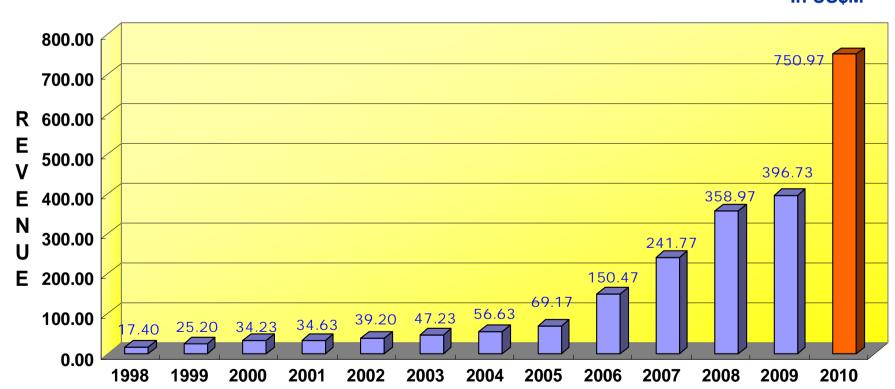


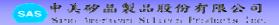
The above cooperation enables SAS to increase the capacity, conversion efficiency and yield rate and reduce the electricity usage



SAS Sales Revenue Trend

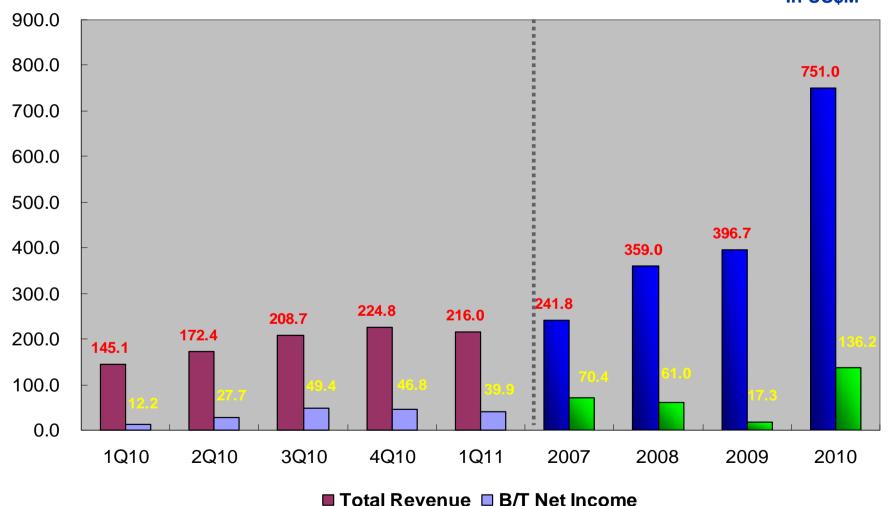
In US\$M





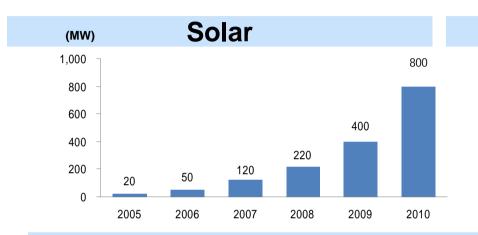
Operating Performance

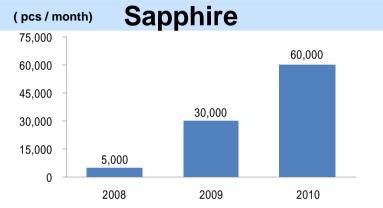
In US\$M



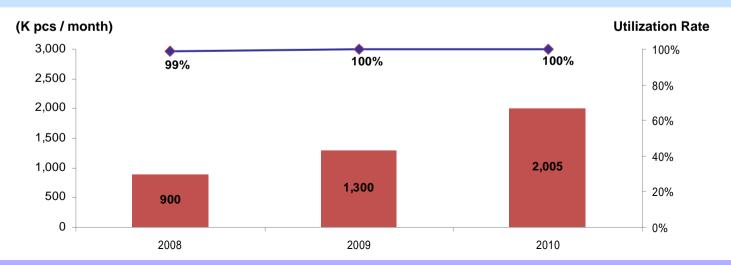


Proven Ability to Scale Manufacturing Capacity Across





Semiconductor



Strong Customer and Supplier Profiles

Leveraging long-term strategic relationships with leading suppliers and customers

Suppliers

- Long-term polysilicon contracts with leading solar wafer producers
- A substantial majority of estimated wafer requirements secured for 2010 and 2011
- Combination of flexible and fixed wafer price contracts

HEC





Customers

- Diversified customer base globally in Europe, Taiwan, Japan, Korea and other Asian countries
- Customers consists of industry leaders across semi, solar and LED
- Focus on long-term relationship











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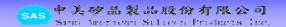








MSHINDENGEN



Quarterly I/S Comparison

In US\$M

	<u>1Q10</u>	<u>2Q10</u>	<u>3Q10</u>	<u>4Q10</u>	2010 Accu.	<u>1Q11</u>
Revenues	145	172	209	225	751	215
Gross Profit	20	37	60	67	184	51
Gross Margin	14%	21%	29%	30%	25%	24%
Operating Expense	8	10	12	12	42	10
Operating Income	12	27	49	54	142	41
Operating Margin	8%	16%	23%	24%	19%	19%
Net Income before Tax	12	28	49	47	136	43
Net Margin	8%	16%	24%	21%	18%	20%
A/T EPS(NT\$)	1.00	2.21	3.95	3.34	10.50	2.93

Mid-Term New Expansion Plan

Items		Target	Location	Ramp-Up Plan
1	Solar Vertical integration	A. 1GW B. 500MW~1GW	A. Taiwan B. Taiwan	A. 2012 B. 2011~
2	Semiconductor	>50% expansion	TWN, USA ,China	2011~
3	Semiconductor	200mm Semiconductor wafer launch	TWN, USA ,China	2H 2011
4	Sapphire	500K pcs/Month	Taiwan	2012~



(SST)



(SSC1, SSC2)

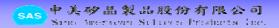


(mid-term Plan)

Factory dedicated to sapphire products including ingots and substrates manufacturing

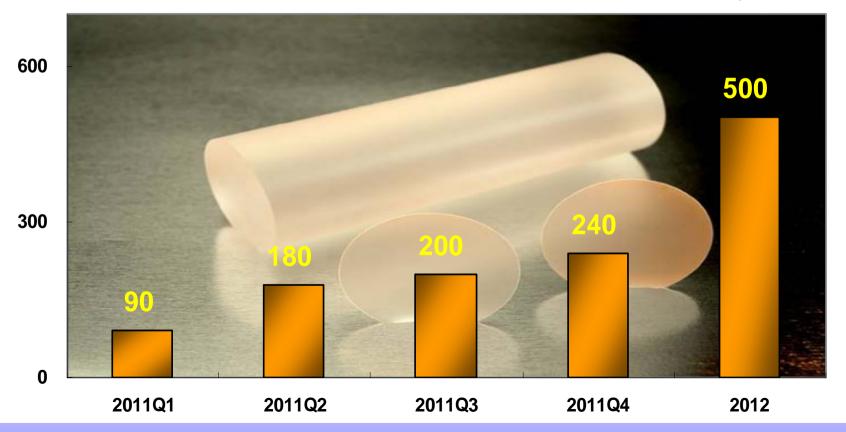
(GTI)

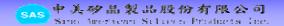




Sapphire Capacity Expansion Plan

Unit:2"/ Kpcs/month



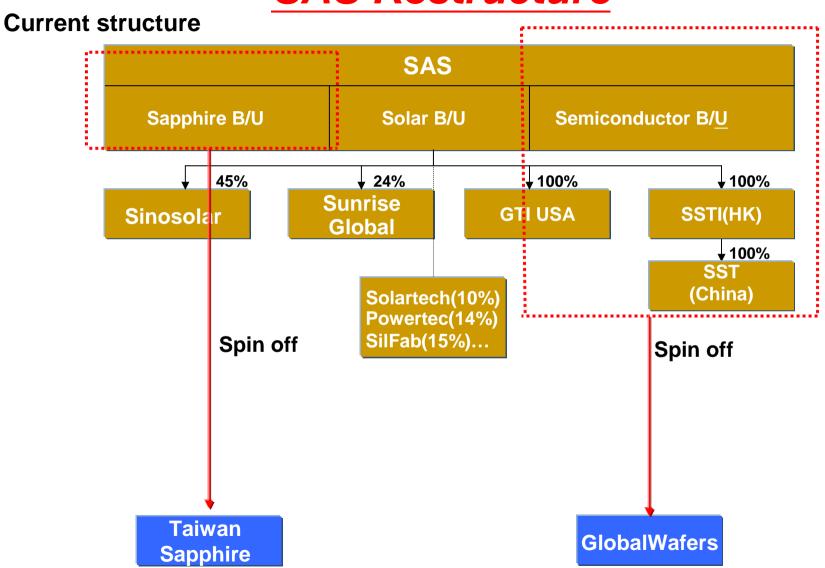


SAS Strategic Path to Growth

"Spin-Off"



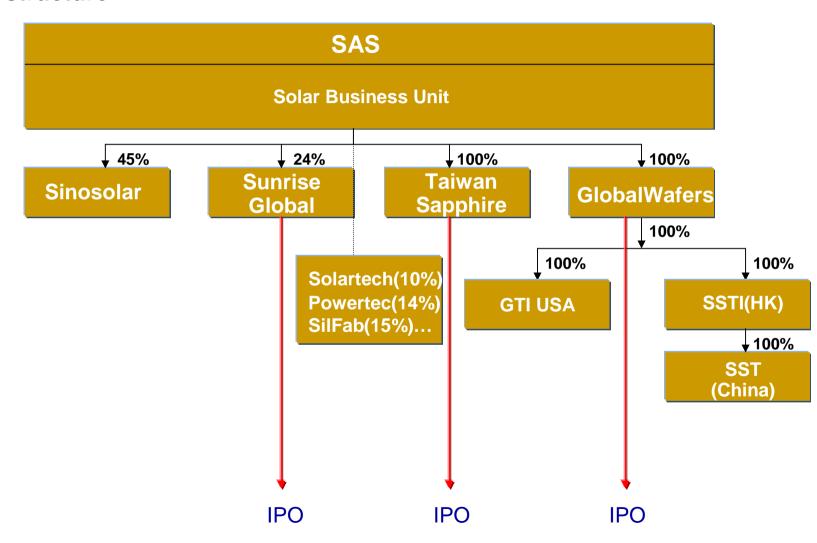
SAS Restructure





SAS Restructure

Future structure



Benefits from Spin-Off

- More space for subsidiary B/U to execute vertical integration activity based on respective industrial landscape.
- Efficient resource allocation leads to maximum group synergy and return on investment.
- More healthy liquidity from future subsidiaries' potential IPOs.
- Visibility help improve subsidiaries to attract talent.
- More transparency on respective B/U operating performance as an appeal to investors for identifying investment targets.
- No impact on existing SAS shareholders' interest.



Strategic Business Development Plan

Globalwafers Corp (Semiconductor)

- 1. Continue to expand Semiconductor wafer and Epitaxy process capacity.
- 2. Agressively to increase 200mm wafer manufacture percentage.
- 3. Developing extra-low-resistance wafer and Epitaxy product.
- **4.IPO**



Strategic Business Development Plan

Taiwan Sapphire Co. (Sapphire)

- 1. Building dedicated Sapphire plant.
- 2. Expanding capacity in all aspects, including Sapphire crystallization, substrate slicing, micro/nano pattern substrate.
- 3. Developing large size Sapphire substrate (4",6")
- 4. Developing Large size Sapphire crystallization technology (90KG grade)
- 5.IPO



Strategic Business Development Plan

SAS (Solar Products)

- 1. Expanding solar wafer capacity.
- 2. Developing next-generation high conversion efficiency mono/multi solar wafer.
- 3. Developing diamond wire slicing technology for multi solar wafer.
- 4. Strengthing vertical integration synergy via reinvestment including Powertech, Sunrise Global, Sinosolar, Silfab...).

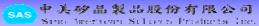














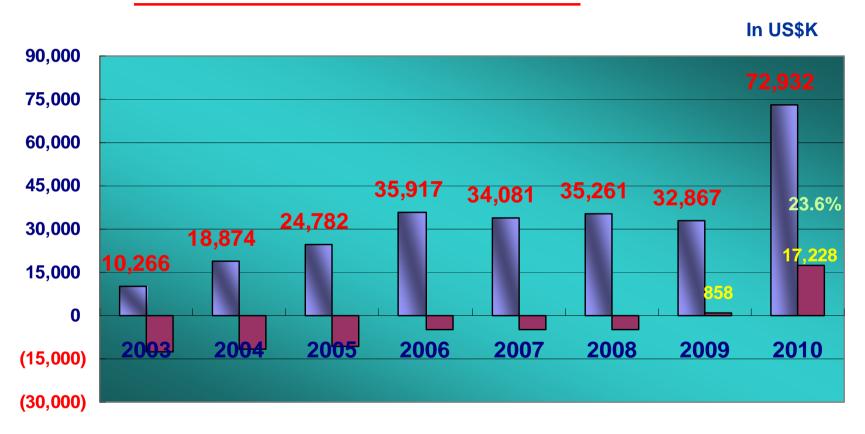
- Two epi reactor models available:
 - LV: Centura single-wafer
 - HV: EpiPro batch reactor
- 100mm/125mm batch reactors
- Diameter 100mm, 125mm, 150mm, 200mm
- Dopant As, P, B
- Multi-layer Epi products available; P/N+, N/P+ available
- Advanced reactor control and data collection (RFID tracking)
- Largest Epi house in North America.







Financials Trend Chart



■ Revenue ■ Profit B/T



GT Key Customers



























Thank you!

http://www.saswafer.com 5483 TT

